## FEATURES

- Ultra Low Dropout Voltage
- Low Ground Pin Current
- Excellent Line and Load Regulation
- Available in SOT-223, TO-252 Package
- Fixed Output Voltages : $1.0 \mathrm{~V}, 1.1 \mathrm{~V}, 1.2 \mathrm{~V}, 1.5 \mathrm{~V}, 1.8 \mathrm{~V}$, 2.5 V , and 3.3 V
- Over-Temperature/Over-Current Protection
- $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ Junction Temperature Range
- Moisture Sensitivity Level 3


## APPLICATION

- Battery Powered Equipments
- Motherboards and Graphic Cards
- Microprocessor Power Supplies
- Peripheral Cards
- High Efficiency Linear Regulators
- Battery Chargers



## DESCRIPTION

The TJ1118 series of high performance ultra low-dropout linear regulators operates from 2.5 V to 5.5 V input supply and provides ultra low-dropout voltage, high output current with low ground current. Wide range of preset output voltage options are available. These ultra low dropout linear regulators respond fast to step changes in load which makes them suitable for low voltage micro-processor applications. The TJ1118 is developed on a CMOS process technology which allows low quiescent current operation independent of output load current. This CMOS process also allows the TJ1118 to operate under extremely low dropout conditions.

## Absolute Maximum Ratings

| CHARACTERISTIC | SYMBOL | MIN. | MAX. | UNIT |
| :--- | :---: | :---: | :---: | :---: |
| Input Supply Voltage (Survival) | $\mathrm{V}_{\text {IN }}$ | -0.3 | 6.5 | V |
| Maximum Output Current | $\mathrm{I}_{\text {MAX }}$ | - | $1.0^{1)}$ | A |
| Lead Temperature (Soldering, 5 sec ) | $\mathrm{T}_{\text {SOL }}$ |  | 260 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {STG }}$ | -65 | 150 | ${ }^{\circ} \mathrm{C}$ |
| Operating Junction Temperature Range | $\mathrm{T}_{\text {JOPR }}$ | -40 | 125 | ${ }^{\circ} \mathrm{C}$ |

1) Refer to the Ordering Information Table in this Data Sheet

## Operating Ratings

| CHARACTERISTIC | SYMBOL | MIN. | MAX. | UNIT |
| :--- | :---: | :---: | :---: | :---: |
| Recommend Operating Input Voltage | $\mathrm{V}_{\text {IN }}$ | 2.5 | 5.5 | V |

## Ordering Information

| Vout | Package | Order No. |  | Description (Maximum Output Current) | Supplied As | Status |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1.0V | SOT-223 3L | TJ1118S | -1.0 | 0.8A | Reel | Contact us |
|  | TO-252 3L | TJ1118GRS |  | 0.8A | Reel | Contact us |
| 1.1V | SOT-223 3L | TJ1118S | -1.1 | 0.8A | Reel | Contact us |
|  | TO-252 3L | TJ1118GRS |  | 0.8A | Reel | Contact us |
| 1.2 V | SOT-223 3L | TJ1118S | -1.2 | 0.8A | Reel | Contact us |
|  | TO-252 3L | TJ1118GRS |  | 0.8A | Reel | Contact us |
| 1.5 V | SOT-223 3L | TJ1118S | -1.5 | 0.8A | Reel | Contact us |
|  | TO-252 3L | TJ1118GRS |  | 0.8A | Reel | Contact us |
| 1.8 V | SOT-223 3L | TJ1118S | -1.8 | 0.8A | Reel | Contact us |
|  | TO-252 3L | TJ1118GRS |  | 0.8A | Reel | Contact us |
| 2.5 V | SOT-223 3L | TJ1118S | -2.5 | 1A | Reel | Contact us |
|  | TO-252 3L | TJ1118GRS | -2.5 | 1A | Reel | Contact us |
| 3.3 V | SOT-223 3L | TJ1118S | -3.3 | 1A | Reel | Contact us |
|  | TO-252 3L | TJ1118GRS |  | 1A | Reel | Contact us |



PIN CONFIGURATION


SOT-223 3L

PIN DESCRIPTION

| Pin No. | SOT-223 / TO-252 3LD |  |
| :---: | :---: | :---: |
|  | Name | Function |
| 1 | GND | Ground |
| 2 | VOUT | Output Voltage |
| 3 | VIN | Input Voltage |

## TYPICAL APPLICATION

- Typical Application Circuit

* TJ1118 can deliver a continuous current of up to $0.8 \mathrm{~A} / 1 \mathrm{~A}$ the full operating temperature. However, the output current is limited by the restriction of power dissipation which differs from packages. A heat sink may be required depending on the maximum power dissipation and maximum ambient temperature of application. With respect to the applied package, the maximum output current of $0.8 \mathrm{~A} / 1 \mathrm{~A}$ may be still undeliverable.
* See Application Information.


## ELECTRICAL CHARACTERISTICS FOR VOUT $\mathbf{\geq 2 . 5} \mathbf{V}^{\text {(Note 1) }}$

Limits in standard typeface are for $\mathbf{T}_{\mathbf{J}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$, and limits in boldface type apply over the full operating temperature range. Unless otherwise specified: $\mathrm{V}_{\mathrm{IN}}{ }^{(\text {Note } 2)}=\mathrm{V}_{\mathrm{O}(\mathrm{NOM})}+1 \mathrm{~V}, \mathrm{I}_{\mathrm{L}}=10 \mathrm{~mA}, \mathrm{C}_{\mathrm{IN}}=10 \mathrm{uF}, \mathrm{Cout}=10 \mathrm{uF}, \mathrm{VOUT} \geq 2.5 \mathrm{~V}$

| PARAMETER | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Voltage Tolerance | $\mathrm{V}_{0}$ | $\begin{aligned} & 10 \mathrm{~mA}<\mathrm{I}_{\mathrm{L}}<1 \mathrm{~A} \\ & \mathrm{~V}_{\text {OUT }}+1 \mathrm{~V}<\mathrm{V}_{\text {IN }}<5.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & -2 \\ & -3 \end{aligned}$ | 0 | 2 3 | \% |
| Output Current | Io | VOUT $\geq 2.5 \mathrm{~V}$ | - | - | 1 | A |
| Line Regulation ${ }^{(\text {Note } 3)}$ | $\Delta \mathrm{V}_{\text {LINE }}$ | $\mathrm{V}_{\text {OUT }}+1 \mathrm{~V}$ < $\mathrm{V}_{\text {IN }}<5.5 \mathrm{~V}$ | - | 0.15 | $0.40$ | \%/V |
| Load Regulation ${ }^{\text {(Note 3, 4) }}$ | $\Delta V_{\text {LOAD }}$ | $10 \mathrm{~mA}<\mathrm{I}_{\mathrm{L}}<1 \mathrm{~A}$ | - | 1.5 | - | \% |
| Dropout Voltage ${ }^{\text {(Note 5) }}$ | $V_{\text {DROP }}$ | $\mathrm{L}_{\mathrm{L}}=100 \mathrm{~mA}$ |  | 55 | 80 | mV |
|  |  | $\mathrm{L}_{\mathrm{L}}=500 \mathrm{~mA}$ |  | 200 | $300$ | mV |
|  |  | $\mathrm{I}=1 \mathrm{~A}$ |  | 450 | $650$ | mV |
| Ground Pin Current ${ }^{\text {(Note 6) }}$ | $\mathrm{I}_{\text {GND } 1}$ | $\mathrm{L}_{\mathrm{L}}=100 \mathrm{~mA}$ | - | 0.12 | 0.15 - | mA |
|  |  | $\mathrm{L}=1 \mathrm{~A}$ | - | 0.12 | 0.20 . |  |
| Power Supply Rejection Ratio | PSRR | $\mathrm{f}=1 \mathrm{kHz}$ | - | 55 | - | dB |
| Thermal Shutdown Temperature | $\mathrm{T}_{\text {SD }}$ |  | - | 165 | - | ${ }^{\circ} \mathrm{C}$ |

Note 1. Stresses listed as the absolute maximum ratings may cause permanent damage to the device. These are for stress ratings. Functional operating of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibly to affect device reliability.
Note 2. The minimum operating value for input voltage is equal to either ( $\mathrm{V}_{\mathrm{OUT}, \mathrm{NOM}}+\mathrm{V}_{\mathrm{DROP}}$ ) or 2.5 V , whichever is greater.
Note 3. Output voltage line regulation is defined as the change in output voltage from the nominal value due to change in the input line voltage. Output voltage load regulation is defined as the change in output voltage from the nominal value due to change in load current.
Note 4. Regulation is measured at constant junction temperature by using a 10 ms current pulse. Devices are tested for load regulation in the load range from 10 mA to 1 A .
Note 5. Dropout voltage is defined as the minimum input to output differential voltage at which the output drops $2 \%$ below the nominal value. Dropout voltage specification applies only to output voltages of 2.5 V and above. For output voltages below 2.5 V , the dropout voltage is nothing but the input to output differential, since the minimum input voltage is 2.5 V .
Note 6. Ground current, or quiescent current, is the difference between input and output currents. It's defined by $I_{G N D 1}=I_{I_{N}}-I_{\text {OUT }}$ under the given loading condition. The total current drawn from the supply is the sum of the load current plus the ground pin current.

Ultra Low Dropout Linear Regulator

## ELECTRICAL CHARACTERISTICS FOR VOUT < 2.5V ${ }^{\text {(Note 1) }}$

Limits in standard typeface are for $\mathrm{T}_{\mathrm{J}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$, and limits in boldface type apply over the full operating temperature range.
Unless otherwise specified: $\mathrm{V}_{\mathrm{IN}^{(\text {Note } 2)}}=\mathrm{V}_{\mathrm{O}(\mathrm{NOM})}+1 \mathrm{~V}, \mathrm{I}_{\mathrm{L}}=10 \mathrm{~mA}, \mathrm{C}_{\mathrm{IN}}=10 \mathrm{uF}, \mathrm{C}_{\text {out }}=10 \mathrm{uF}$, VOUT $<2.5 \mathrm{~V}$

| PARAMETER | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Voltage Tolerance | Vo | $\begin{aligned} & 10 \mathrm{~mA}<\mathrm{I}_{\mathrm{L}}<800 \mathrm{~mA} \\ & \mathrm{~V}_{\text {OUT }}+1 \mathrm{~V}<\mathrm{V}_{\text {IN }}<5.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & -2 \\ & -3 \end{aligned}$ | 0 | $\begin{aligned} & 2 \\ & 3 \end{aligned}$ | \% |
| Output Current | Io | VOUT < 2.5V | - | - | 0.8 | A |
| Line Regulation ${ }^{(\text {Note } 3)}$ | $\Delta \mathrm{V}_{\text {LINE }}$ | $\mathrm{V}_{\text {OUT }}+1 \mathrm{~V}$ < $\mathrm{V}_{\text {IN }}<5.5 \mathrm{~V}$ | - | 0.15 | $0.40$ | \%/V |
| Load Regulation ${ }^{\text {(Note 3, 7) }}$ | $\Delta \mathrm{V}_{\text {LOAD }}$ | $10 \mathrm{~mA}<\mathrm{I}_{\mathrm{L}}<800 \mathrm{~mA}$ | - | 1.5 | - | \% |
| Dropout Voltage ${ }^{\text {(Note 5) }}$ | $V_{\text {DROP }}$ | $\mathrm{I}_{\mathrm{L}}=100 \mathrm{~mA}$ |  | 55 | 80 | mV |
|  |  | $\mathrm{I}_{\mathrm{L}}=500 \mathrm{~mA}$ |  | 200 | $300$ | mV |
|  |  | $\mathrm{I}_{\mathrm{L}}=800 \mathrm{~mA}$ |  | 450 | $650$ | mV |
| Ground Pin Current ${ }^{(\text {Note 6) }}$ | $\mathrm{I}_{\text {GND } 1}$ | $\mathrm{L}_{\mathrm{L}}=100 \mathrm{~mA}$ | - | 0.12 | 0.15 - | mA |
|  |  | $\mathrm{L}_{\mathrm{L}}=800 \mathrm{~mA}$ | - | 0.12 | 0.20 - |  |
| Power Supply Rejection Ratio | PSRR | $\mathrm{f}=1 \mathrm{kHz}$ | - | 55 | - | dB |
| Thermal Shutdown Temperature | $\mathrm{T}_{\text {SD }}$ |  | - | 165 | - | ${ }^{\circ} \mathrm{C}$ |

Note 7. Regulation is measured at constant junction temperature by using a 10 ms current pulse. Devices are tested for load regulation in the load range from 10 mA to 800 mA .

## Ultra Low Dropout Linear Regulator

## TYPICAL OPERATING CHARACTERISTIC


(VIN: 2V/div, VOUT: 2V/div, 1ms/div)
Vin=3.5V, Vout=2.5V @ lout=0A
Start Up Transient Response

(VIN: 2V/div, VOUT: 20mV/div, 10ms/div)
Vin=3.5V to 5.5 V , Vout=2.5V @ lout=10mA
Line Transient Response

(VOUT: $50 \mathrm{mV} / \mathrm{div}$, lout: $500 \mathrm{~mA} / \mathrm{div}, 10 \mathrm{~ms} / \mathrm{div}$ )
Vin=3.5V, Vout=2.5V @ lout=10mA to 0.5A
Load Transient Response

(VIN: 2V/div, VOUT: 2V/div, 1ms/div)
Vin=3.5V, Vout=2.5V @ lout=1A
Start Up Transient Response

(VIN: 2V/div, VOUT: 20mV/div, 10ms/div)
Vin=5.5V to 3.5 V , Vout=2.5V @ lout=10mA
Line Transient Response

(VOUT: $50 \mathrm{mV} / \mathrm{div}$, lout: $500 \mathrm{~mA} / \mathrm{div}, 10 \mathrm{~ms} / \mathrm{div}$ )
Vin=3.5V, Vout=2.5V @ lout=0.5A to 10 mA
Load Transient Response

(VOUT: $50 \mathrm{mV} / \mathrm{div}$, lout: $500 \mathrm{~mA} / \mathrm{div}, 10 \mathrm{~ms} / \mathrm{div}$ )
Vin=3.5V, Vout=2.5V @ lout=10mA to 1 A
Load Transient Response


Dropout Voltage vs. Ambient Temperature

(VOUT: $50 \mathrm{mV} / \mathrm{div}$, lout: $500 \mathrm{~mA} / \mathrm{div}, 10 \mathrm{~ms} / \mathrm{div}$ ) Vin=3.5V, Vout=2.5V @ lout=1A to 10 mA Load Transient Response


Power Supply Rejection
Ratio

## APPLICATION INFORMATION

## Introduction

TJ1118 is intended for applications where high current capability and very low dropout voltage are required. It provides a simple, low cost solution that occupies very little PCB estate.

## Component Selection

## Input Capacitor :

A large bulk capacitance over than 4.7 uF should be closely placed to the input supply pin of the TJ1118 to ensure that the input supply voltage does not sag. Also a minimum of 4.7 uF ceramic capacitor is recommended to be placed directly next to the $\mathrm{V}_{\mathrm{IN}}$ Pin. It allows for the device being some distance from any bulk capacitor on the rail. Additionally, input droop due to load transients is reduced, improving load transient response.

## Output Capacitor :

A minimum ceramic capacitor over than 4.7 uF should be very closely placed to the output voltage pin of the TJ1118. Increasing capacitance will improve the overall transient response and stability.

## Maximum Output Current Capability

The TJ1118 can deliver a continuous current of $0.8 \mathrm{~A} / 1 \mathrm{~A}$ over the full operating junction temperature range. However, the output current is limited by the restriction of power dissipation which differs from packages. A heat sink may be required depending on the maximum power dissipation and maximum ambient temperature of application. With respect to the applied package, the maximum output current of $0.8 \mathrm{~A} / 1 \mathrm{~A}$ may be still undeliverable due to the restriction of the power dissipation of TJ1118. Under all possible conditions, the junction temperature must be within the range specified under operating conditions.
The temperatures over the device are given by:

$$
T_{C}=T_{A}+P_{D} \times \theta_{C A} / T_{J}=T_{C}+P_{D} \times \theta_{J C} / \quad T_{J}=T_{A}+P_{D} X \theta_{J A}
$$

where $T_{J}$ is the junction temperature, $T_{C}$ is the case temperature, $T_{A}$ is the ambient temperature, $P_{D}$ is the total power dissipation of the device, $\theta_{\mathrm{CA}}$ is the thermal resistance of case-to-ambient, $\theta_{\mathrm{Jc}}$ is the thermal resistance of junction-to-case, and $\theta_{\mathrm{JA}}$ is the thermal resistance of junction to ambient.
The total power dissipation of the device is given by:

$$
\begin{aligned}
\mathrm{P}_{\mathrm{D}}=\mathrm{P}_{\mathrm{IN}}-\mathrm{P}_{\text {OUT }} & =\left(\mathrm{V}_{\text {IN }} \times \mathrm{I}_{\text {IN }}\right)-\left(\mathrm{V}_{\text {OUT }} \mathrm{X} \mathrm{I}_{\text {OUT }}\right) \\
& =\left(\mathrm{V}_{\text {IN }} \mathrm{X}\left(\mathrm{I}_{\text {OUT }}+\mathrm{I}_{\text {GND }}\right)\right)-\left(\mathrm{V}_{\text {OUT }} X \mathrm{I}_{\text {OUT }}\right)=\left(\mathrm{V}_{\text {IN }}-\mathrm{V}_{\text {OUT }}\right) X \mathrm{I}_{\text {OUT }}+\mathrm{V}_{\text {IN }} X \mathrm{I}_{\text {GND }}
\end{aligned}
$$

where $I_{G N D}$ is the operating ground current of the device which is specified at the Electrical Characteristics. The maximum allowable temperature rise ( $\mathrm{T}_{\mathrm{Rmax}}$ ) depends on the maximum ambient temperature ( $\mathrm{T}_{\text {Amax }}$ ) of the application, and the maximum allowable junction temperature ( $\mathrm{T}_{\mathrm{Jmax}}$ ):

$$
\mathrm{T}_{\mathrm{Rmax}}=\mathrm{T}_{\mathrm{Jmax}}-\mathrm{T}_{\text {Amax }}
$$

The maximum allowable value for junction-to-ambient thermal resistance, $\theta_{\mathrm{JA}}$, can be calculated using the formula:

$$
\theta_{J A}=T_{R \max } / P_{D}=\left(T_{J \max }-T_{A \max }\right) / P_{D}
$$

TJ1118 is available in SOT-223, and TO-252 packages. The thermal resistance depends on amount of copper area or heat sink, and on air flow. If the maximum allowable value of $\theta_{\mathrm{JA}}$ calculated above is as described in Table 1, no heat sink is needed since the package can dissipate enough heat to satisfy these requirements. If the value for allowable $\theta_{\mathrm{JA}}$ falls near or below these limits, a heat sink or proper area of copper plane is required.

Table. 1. Absolute Maximum Ratings of Thermal Resistance
No heat sink / No air flow / No adjacent heat source $/ \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| Characteristic | Symbol | Rating | Unit |
| :--- | :---: | :---: | :---: |
| Thermal Resistance Junction-To-Ambient / SOT-223 | $\theta_{\text {JA-SOT223 }}$ | 140 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Thermal Resistance Junction-To-Ambient / TO-252 | $\theta_{\text {JA-TO252 }}$ | 105 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

In case that there is no cooling solution and no heat sink / minimum copper plane area for heat sink, the maximum allowable power dissipation of each package is as follow;

| Characteristic | Symbol | Rating | Unit |
| :--- | :--- | :--- | :--- |
| Maximum Allowable Power Dissipation at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C} /$ SOT-223 | $\mathrm{P}_{\mathrm{DMax}-\text { SOT223 }}$ | 0.714 | W |
| Maximum Allowable Power Dissipation at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C} / \mathrm{TO}-252$ | $\mathrm{P}_{\mathrm{DMax}-\mathrm{TO252}}$ | 0.952 | W |

- Please note that above maximum allowable power dissipation is based on the minimum copper plane area which does not exceed the proper footprint of the package. And the ambient temperature is $25^{\circ} \mathrm{C}$.

If proper cooling solution such as heat sink, copper plane area, air flow is applied, the maximum allowable power dissipation could be increased. However, if the ambient temperature is increased, the allowable power dissipation would be decreased.

For example, in case of SOT-223 and TO-252 package, $\theta_{\text {JA-sote2z3 }}$ is $140^{\circ} \mathrm{C} / \mathrm{W}$ and $\theta_{\mathrm{JA}-\text { TO52 }}$ is $105^{\circ} \mathrm{C} / \mathrm{W}$, however, as shown in below graph, $\theta_{\mathrm{JA}}$ could be decreased with respect to the copper plane area. So, the specification of maximum power dissipation for an application is fixed, the proper copper plane area could be estimated by following graphs. As shown in graph, wider copper plane area leads lower $\theta_{\mathrm{JA}}$.


The maximum allowable power dissipation is also influenced by the ambient temperature. With the above $\theta_{\mathrm{JA}}$-Copper plane area relationship, the maximum allowable power dissipation could be evaluated with respect to the ambient temperature. As shown in graph, the higher copper plane area leads $\theta_{\mathrm{JA}}$. And the higher ambient temperature leads lower maximum allowable power dissipation.


All this relationship is based on the aforesaid equation ; $\theta_{J A}=T_{R \max } / P_{D}=\left(T_{J \max }-T_{A \max }\right) / P_{D}$.

